

IPW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chad A. Cobbley et al

Serial No.: 10/672,750

Filed: September 25, 2003

For: STACKED DIE MODULE AND  
TECHNIQUES FOR FORMING A  
STACKED DIE MODULE

Group Art Unit: 2811

Examiner: Blum, David S.

Atty Docket: MICS:0078—1/FLE/MAN  
(01-0752.01)

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

CERTIFICATE OF TRANSMISSION OR MAILING  
37 C.F.R. 1.8

I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office in accordance with 37 C.F.R. 1.6(d) or is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, Alexandria, VA 22313, on the date below:

January 28, 2005  
Date

*Kerri Hyland*  
Kerri Hyland

**RESPONSE TO OFFICE ACTION DATED DECEMBER 1, 2004**

Sir:

In response to the Office Action dated December 1, 2004, please amend the above-identified application as follows: